# **DSC7004**

## Silicon NPN epitaxial planar type

For low frequency amplification Complementary to DSA7004

#### ■ Features

- ullet Low collector-emitter saturation voltage  $V_{\text{CE(sat)}}$
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

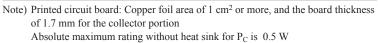
## ■ Marking Symbol: 5B

#### Packaging

 $DSC7004 \times 0L \quad Embossed \ type \ (Thermo-compression \ sealing): 1000 \ pcs \ / \ reel \ (standard)$ 

## ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	60	V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	50	V
Emitter-base voltage (Collector open)	V <sub>EBO</sub> 5		V
Collector current	I <sub>C</sub> 2		A
Peak collector current	$I_{CP}$	3	A
Collector power dissipation	P <sub>C</sub>	1	W
Junction temperature	T <sub>j</sub>	150	°C
Operating ambient temperature	T <sub>opr</sub>	-40 to +85	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C



## Unit: mm 4.5 1.6 0.41 <u>0.</u> 5 0.4 1.5 3.0 1: Base 2: Collector 3: Emitter Panasonic MiniP3-F2-B **JEITA** SC-62 TO-243 Code

## ■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = 10 \ \mu A, I_{\rm E} = 0$	60			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 1 \text{ mA}, I_B = 0$	50			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 10 \mu A, I_C = 0$	5			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 20 \text{ V}, I_{E} = 0$			0.1	μΑ
Forward current transfer ratio *1	h <sub>FE1</sub> *2	$V_{CE} = 2 \text{ V}, I_{C} = 200 \text{ mA}$	120		340	
	h <sub>FE2</sub>	$V_{CE} = 2 \text{ V}, I_{C} = 1 \text{ A}$	80			_
Collector-emitter saturation voltage *1	V <sub>CE(sat)</sub>	$I_C = 1 \text{ A}, I_B = 50 \text{ mA}$		0.15	0.3	V
Base-emitter saturation voltage *1	V <sub>BE(sat)</sub>	$I_C = 1 \text{ A}, I_B = 50 \text{ mA}$		0.9	1.2	V
Transition frequency	$f_T$	$V_{CE} = 10 \text{ V}, I_{C} = 50 \text{ mA}$		120		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		22	35	pF

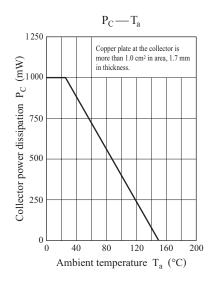
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

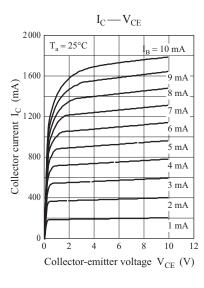
### 2. \*1: Pulse measurement

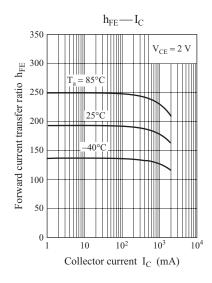
#### \*2: Rank classification

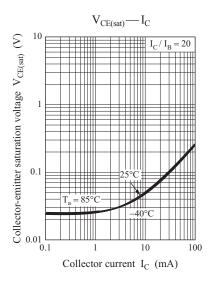
Code	R	S	0	
Rank	R	S	No-rank	
$h_{\mathrm{FE1}}$	120 to 240	170 to 340	120 to 340	
Marking Symbol	5BR	5BS	5B	

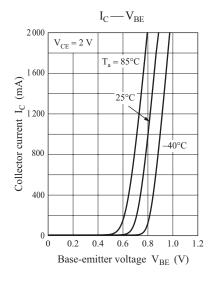
Product of no-rank is not classified and have no marking symbol for rank.

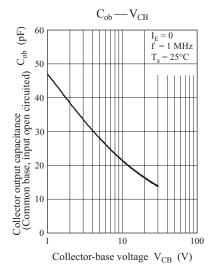


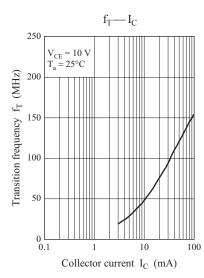








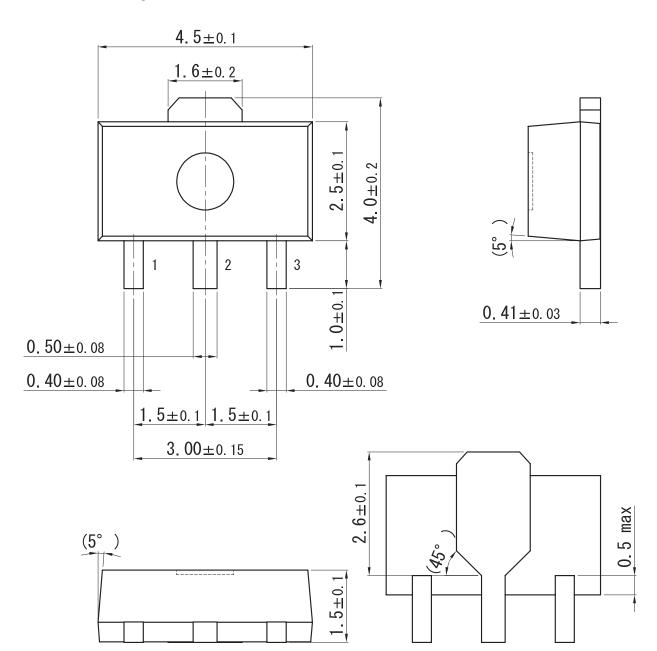




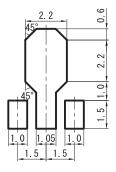
Ver. EED 2

## MiniP3-F2-B

Unit: mm



## ■ Land Pattern (Reference) (Unit: mm)



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